

PATENT APPLICATION
IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re application of	Docket No: Q96975
Takayuki ARAKI, et al.	
Appln. No.: 10/593,299	Group Art Unit: 1711
Confirmation No.: 8429	Examiner: Unknown
Filed: September 18, 2006	
For: METHOD OF FORMING THIN FILM OF VINYLIDENE FLUORIDE HOMOPOLYMER	

REQUEST FOR CORRECTED OFFICIAL FILING RECEIPT

ATTN: Office of Initial Patent Examination
Filing Receipt Correction
Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Sir:

We enclose a copy of the Official Filing Receipt for the above-identified application and request the following correction:


Assignment for Published Patent Application

DAIKIN INDUSTRIES, LTD., OSAKA, JAPAN

DAIKIN INDUSTRIES, LTD. (should be with a comma and period)

Verification for the requested correction is indicated on the executed Assignment
Document filed September 18, 2006.

Respectfully submitted,



Abraham J. Rosner
Registration No. 33,276

SUGHRUE MION, PLLC
Telephone: (202) 293-7060
Facsimile: (202) 293-7860

WASHINGTON OFFICE

23373
CUSTOMER NUMBER

Date: May 23, 2007



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APPL NO.	FILING OR 371 (c) DATE	ART UNIT	FIL FEE REC'D	ATTY. DOCKET NO	TOT CLMS	IND CLMS
10/593,299	09/18/2006	1711	1300	Q86975	20	5

CONFIRMATION NO. 8429

23373
SUGHRUE MION, PLLC
2100 PENNSYLVANIA AVENUE, N.W.
SUITE 800
WASHINGTON, DC 20037

DOCKETED**MAY 11 2007**

FILING RECEIPT

1 2 3 4 5 6 7 8 9 10 11 12 13 14 15 16 17 18 19 20 21 22 23 24 25 26 27 28 29 30 31 32 33 34 35 36 37 38 39 40 41 42 43 44 45 46 47 48 49 50 51 52 53 54 55 56 57 58 59 60 61 62 63 64 65 66 67 68 69 70 71 72 73 74 75 76 77 78 79 80 81 82 83 84 85 86 87 88 89 90 91 92 93 94 95 96 97 98 99 00
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Date Mailed: 05/09/2007

Receipt is acknowledged of this regular Patent Application. It will be considered in its order and you will be notified as to the results of the examination. Be sure to provide the U.S. APPLICATION NUMBER, FILING DATE, NAME OF APPLICANT, and TITLE OF INVENTION when inquiring about this application. Fees transmitted by check or draft are subject to collection. Please verify the accuracy of the data presented on this receipt. If an error is noted on this Filing Receipt, please mail to the Commissioner for Patents P.O. Box 1450 Alexandria Va 22313-1450. Please provide a copy of this Filing Receipt with the changes noted thereon. If you received a "Notice to File Missing Parts" for this application, please submit any corrections to this Filing Receipt with your reply to the Notice. When the USPTO processes the reply to the Notice, the USPTO will generate another Filing Receipt incorporating the requested corrections (if appropriate).

Applicant(s)

Takayuki Araki, Osaka, JAPAN;
Tetsuhiko Kodani, Osaka, JAPAN;

Assignment For Published Patent Application

[DAIKIN INDUSTRIES, LTD., OSAKA, JAPAN]

DAIKIN INDUSTRIES, LTD.

Power of Attorney: The patent practitioners associated with Customer Number 23373.

Domestic Priority data as claimed by applicant

This application is a 371 of PCT/JP05/04102 03/09/2005

Foreign Applications

JAPAN 2004-083289 03/22/2004
JAPAN 2004-231250 08/06/2004

If Required, Foreign Filing License Granted: 05/09/2007

The country code and number of your priority application, to be used for filing abroad under the Paris Convention, is **US10/593,299**

Projected Publication Date: 08/16/2007

Assignment

Whereas, ¶We, Takayuki ARAKI and Tetsuhiro KODANI of c/o Yodogawa-
seisakusho, DAIKIN INDUSTRIES, LTD., 1-1, Nishihitotsuya, Settsu-shi, Osaka
566-8585 Japan

hereinafter called assignor(s), have invented certain improvements in

METHOD OF FORMING THIN FILM OF VINYLIDENE FLUORIDE HOMOPOLYMER

and executed an application for Letters Patent of the United States of America therefor on
even date herewith; and

Whereas,

DAIKIN INDUSTRIES, LTD. residing at Umeda
Center Building, 4-12, Nakazaki-Nishi 2-Chome,
Kita-ku, Osaka-shi, Osaka 530-8323 Japan

(assignee), desires to acquire the entire right, title, and interest in the application and
invention, and to any United States patents to be obtained therefor;

Now therefore, for valuable consideration, receipt whereof is hereby acknowledged,

¶We, the above named assignor(s), hereby sell, assign and transfer to the above named
assignee, its successors and assigns, the entire right, title and interest in the application and the
invention disclosed therein for the United States of America, including the right to claim priority
under 35 U.S.C. §119, and ¶we request the Director - U.S. Patent and Trademark Office to issue
any Letters Patent granted upon the invention set forth in the application to the assignee, its
successors and assigns; and ¶we will execute without further consideration all papers deemed
necessary by the assignee in connection with the United States application when called upon to
do so by the assignee.

¶We hereby authorize and request our attorneys SUGHRUE MION, PLLC of 2100
Pennsylvania Avenue, NW, Washington, DC 20037-3213 to insert here in parentheses
(Application number _____ and Confirmation number
_____, filed _____) the filing date
and application number of said application when known.

Date: March 22, 2005 Takayuki Araki
s/

Date: March 30, 2005 Tetsuhiro Kodani
s/

Date: _____
s/